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To the Director of the United States Patent and Trademark Office: Please record the attached original documents or copies thereof.

1. Name of conveying party(ies):

10-27-00

Kenji TOKUNAGA

2. Name and address of receiving party(ies):

Semiconductor Leading Edge Technologies, Inc. 292 Yoshida-cho, Totsuka-ku Yokohama, Kanagawa 244-0817 Japan



Additional conveying party(ies) attached?

NO

3. Nature of conveyance:

ASSIGNMENT

Execution Date:

September 25, 2000

Additional name(s) & address(es) attached?

4. Application number(s) or patent number(s):

If this is being filed together with a new application, the execution date of the application

September 25, 2000

is:

A. Patent Application Number(s):

B. Patent Number(s):

Additional numbers attached? NO

9

5. Name and address of party to whom correspondence

6. Total number of applications/patents involved: 1

concerning document should be mailed:

\$40.00 7. Total fee (37 C.F.R. § 3.41):

William T. Ellis FOLEY & LARDNER Washington Harbour 3000 K Street, N.W., Suite 500 Washington, D.C. 20007-5109

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October 27, 2000

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002.405936

PATENT REEL: 011252 FRAME: 0493 ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

Kenji TOKUNAGA

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

c/o Semiconductor Leading Edge Technologies, Inc 292 Yoshida-cho, Totsuka-ku, Yokohama, Kanagawa 244-0817 <u>JAPAN</u>

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

SYSTEM FOR SUBSTRATE PROCESSING SYSTEM, AND METHOD OF SUBSTRATE

for which an application for United States Letters Patent was executed on even date herewith,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the international Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

INVENTOR

DATE SIGNED

Sept. 25, 2000

RECORDED: 10/27/2000

PATENT

REEL: 011252 FRAME: 0494

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